

Characterizing New Detectors for SuperCDMS SNOLAB

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A new era for the Cryogenic Dark Matter Search

- 12 years of operation at the Soudan Underground Laboratory, now complete
- Currently building the next phase: SuperCDMS SNOLAB



Basic CDMS Technology: Sensing Phonons

- Cryogenic semiconductor detectors: Ge or Si at < 0.1 K
- Athermal phonon sensors on detector surfaces
- Two populations of phonons:
 - Interaction energy
 - Neganov-Trofimov-Luke effect: phonons from drifting ionized charges through applied field



$$E_{phonon} = E_{interaction} + V_{bias} \times Q_{ionization}$$

CDMS II Soudan era

The **ZIP** detector (Z-sensitive Ionization + Phonon)

- Four phonon sensor arrays on 1 side
- Simultaneous ionization measurement
- V_{bias} of a few V

Sense phonons and ionization → independently determine Interaction Energy & Ionization Efficiency (Yield).

 Ionization Yield characteristically smaller for WIMP-signal (nuclear recoils, NR) versus γ and charged background (electron recoils, ER)



0.24 kg (Ge), 0.11 kg (Si)



SuperCDMS Soudan era: iZIP

Near-surface ERs often have reduced yield, making them look like NRs...

The **iZIP** detector (ZIP with interleaved phonon and ionization sensors)

- Ionization electrodes on each side with interleaved ground rails – *improved sensitivity to surface events*
- Four phonon sensor arrays on each side
- Twice as many channels per detector, but detector more than twice as large





0.60 kg (Ge), 0.26 kg (Si)

Testing SuperCDMS Detectors

CDMSlite (Soudan era)

To probe smaller WIMP masses (<< 10 GeV), you need lower energy thresholds than ZIPs and iZIPs provide

CDMSlite: iZIP detectors wired and operated differently:

- Phonon channels read out on one side only (ground side)
- Other side biased to >50 V
- High gain from Luke phonons improves phonon energy resolution, reduces energy threshold
- ER/NR discrimination sacrificed for improved low-energy sensitivity



0.60 kg (Ge), 0.26 kg (Si)



The future: SuperCDMS SNOLAB

Detector designs for SNOLAB build on past CDMS experience

- New **iZIP**s with more phonon sensors, sensor design improvements
- CDMS-HV detectors: inspired by CDMSlite
 - phonon readout on both sides
 - new optimized sensor design
- 2.4× larger detectors



1.38 kg (Ge), 0.60 kg (Si)



Initial 4-tower payload Room for a total of 31 towers

Testing SuperCDMS Detectors

SuperCDMS SNOLAB science reach



Projected WIMP exclusion sensitivity (using the "goal" performance parameters)

SuperCDMS SNOLAB technical parameters

Description	Required	Goal
HV detectors		
Phonon energy resolution (σ) for Ge (Si)	50(35) eV _t	10(7) eV _t
Minimum bias voltage	50 V	100 V
iZIP detectors		
Phonon energy resolution (σ) for Ge (Si)	100(50) eV _t	50(25) eV _t
Charge energy resolution (σ) for Ge (Si)	300(330) eV _{ee}	160(180) eV _{ee}

Technical requirements and goals

	Design Value	
Parameter	CDMS-HV	iZIP
TES Critical Temperature (T _c)	40-45 mK	40-60 mK
Energy Efficiency (ϵ_{E})	15%	13%
Phonon Falltime (τ _{phonon}), Ge	200 µs	1400 μs
Phonon Falltime (τ_{phonon}), Si	40 µs	300 μs
Charge Collection Efficiency	N/A	95%

Design parameters projected from performance of previous designs & smaller R&D devices.

This talk:

first test results from full-sized prototype detectors

Design parameters

Testing prototypes at Minnesota

Limitations:

- Retrofitting to old electronics and hardware
- Only 1-sided readout on HV detectors
- Unavoidable muon background, much higher than deep underground sites

Detector resolutions can't be directly measured due to limitations in the test electronics What can be measured:

- Charge collection efficiency
- Phonon collection efficiency
- Ability to hold high bias voltage
- Phonon sensor critical temperatures
- Phonon pulse rise and fall times
- Qualitative event reconstruction characterization

K100 test facility at UMN

2017 August 1

Charge collection efficiency

At low iZIP biases , charge signals can be degraded due to carrier trapping. Bigger problem in larger crystals. Also uniformity with radius must be verified. High efficiency \rightarrow improved ionization resolution, reduced position variations



100mm Ge iZIP prototypes have been shown to achieve near-maximum efficiency at biases around 4 V or less

Charge collection efficiency

At low iZIP biases , charge signals can be degraded due to carrier trapping. Bigger problem in larger crystals. Also uniformity with radius must be verified. High efficiency \rightarrow improved ionization resolution, reduced position variations



60 keV peak position constant at four different radial positions. Verification that charge collection is uniform across entire 50mm radius.

Phonon collection efficiency

Phonon collection efficiency (PCE): fraction of phonons that are collected to produce a signal

Direct effect on phonon energy resolution.





Ge iZIP PCE versus interaction energy

Measured efficiency is 13% and constant up to nearly 1 MeV

Good match to design goal

Phonon collection efficiency

Phonon collection efficiency (PCE): fraction of phonons that are collected to produce a signal

Direct effect on phonon energy resolution.





Si CDMS-HV PCE versus total phonon energy, based on several Am-241 peaks at various biases.

Efficiency falls at high energies due to localized sensor saturation. Region of interest is low energies, where efficiency approaches 21-22%.

Good match to design goal.

Ability to hold high bias voltage

At high bias, current leakage can occur (seen as strong noise in all channels) – "breakdown" voltage. Design aim to minimize this effect.



Ge and Si CDMS-HV prototypes show breakdown at or below 100 V

Below breakdown less dramatic effects can still occur – higher bias → higher phonon sensor noise (possibly related to high muon-rate in surface testing.)

"Pre-biasing" – overshooting the bias by ≈ 10% for a few minutes – significantly decreases the extra noise.

Good match to performance goal.

Phonon sensor critical temperatures

Phonon sensors operated at their s/c critical temperatures (transition-edge sensors)

$$\sigma_{p,E} \approx \frac{T_c^3}{\epsilon_E} \sqrt{\frac{2}{5} k_B K \tau_{phonon}}$$

Strong effect on resolution

Design target: minimize T_c within cryogenic system constraints .



Phonon pulse fall time

Phonon resolution weakly dependent on phonon pulses fall time.

$$\sigma_{p,E} \approx \frac{T_c^3}{\epsilon_E} \sqrt{\frac{2}{5} k_B K \tau_{phonon}}$$

Fall times are also strong indicator of position sensitivity (small fall times \rightarrow more position information), important for fiducialization in CDMS-HV detectors



Phonon pulse fall time versus interaction energy measured for Si CDMS-HV prototype.

Increasing fall time with energy is likely a saturation effect.

Fall time approaches 45 µs at low energy.

Close match to design goal.

Position reconstruction in iZIP prototype



Position reconstruction in CDMS-HV prototype



Future detector tests

- Run detectors with new electronics chain, demonstration of detector resolution

 at SLAC
- •Run detectors in deep underground site, with very low muon rate
 - at CUTE, testing facility under construction in SNOLAB

Technical requirements have been satisfied; future tests will show to what extent we've exceeded performance goals Learn more about

SuperCDMS SNOLAB

at the

SiDet Tour

Friday 1:30 – 3:00



The CDMS Collaboration





backup

Measured performance parameters

Parameter	Requirement	Design Value	Measurement	Reference
ϵ_{eh}	70%	95%	90-100%	Figure 29
			90%	Figure 33
ϵ_E				
iZIP Ge	8%	13%	13%	Figure 30
iZIP Si	8%	13%	22%	Figure 31
CDMS-HV Ge	8%	15%	12%	Figure 30
CDMS-HV Si	8%	15%	12%	Figure 32
$\tau_{phonon} \ (\mu s)$				
iZIP Ge	2000	1400	~ 1500	Figure 34
iZIP Si	600	300	~ 300	Scaled from Figures 32&34
CDMS-HV Ge	400	200	~ 200	Figure 35
CDMS-HV Si	80	40	45	Figure 32

Table 5: Measured detector signal performance, including ionization collection efficiency, phonon collection efficiency, and phonon falltime (bandwidth) measurements. The measurements include references to figures in this section. In all cases, the measurements exceed by large margins the values needed to achieve the Table 2 technical requirement values, demonstrating full validation of the signal aspect of the resolution modeling for all four detector types.

Ionization yield in iZIP prototype

Pb-210 source pointing at Side 1

Green events pass chargesymmetry cut



Ionization Yield-based discrimination



- Calibration sources:
- ⁷¹Ge internal activation (gamma)
- ²⁴¹Am near detector (gamma)
- ²⁵²Cf outside fridge (gamma and neutron)
- Ionization Yield (defined as charge/energy normalized to the electron-recoil value) as a tool for discriminating the most common events: gammas from radioactivity in the materials near the detector.
- Requires ionization measurement plus an independent measurement of deposited energy

CDMS-HV prototype position reconstruction



Example of position sensitivity: x-y position based on only the Side 1 inner-ring channels. "Delay" and "partition" reconstruction have complementary angular sensitivity

Measuring ionization



- Establish electric field through detector to drift charges to surfaces
 - sub-Kelvin Ge and Si are good insulators \rightarrow nearly zero "leakage" current
- Current induced on electrodes as ionization charges move
- Signal amplified
- Total charge in current pulse = magnitude of ionization

Charge collection efficiency

 ²⁴¹Am source near detector surface provides single-carrier event population – probe electron and hole transport properties separately



Optimizing ionization yield resolution

60 keV ER-band Yield Resolution



 With "iZIP" detectors we typically apply equal and opposite biases to the two sides. For this iZIPv6, the optimal voltage is around +4/-4 V (8 V in terms of Luke phonon production).

CDMS phonon detectors: QETs

Quasiparticle-assisted Electrothermal Feedback = QET

- Superconducting aluminum phonon absorber, $T_c = 1.2$ K
- Broken Cooper-pair quasiparticles
- Diffuse and get trapped by superconducting tungsten biased to transition temperature (Transition Edge Sensor = TES), $T_c \approx 80$ mK
- Temperature increase in TES causes very large change in resistance



Phonon signal amplification

Electrothermal feedback:

- Phonons heat TES
- TES resistance increases
- Bias current through TES is reduced
- which allows TES to cool back to T_c

Superconducting Quantum Interference Device (SQUID):

- Change in TES current measured by SQUID array (low-noise, very sensitive)
- Feedback circuit keeps SQUID array at lockpoint voltage





CDMS-HV phonon sensor design



Figure 11: (Left) Diagram of the SuperCDMS HV athermal phonon sensor design. (Middle) Closeup of the W TES and its connections to the Al phonon collection fins. (Right top) Heuristic cross-sectional view of the athermal phonon sensor.

Si CDMS-HV Sensitivity



Design validation

Detector performance parameters have been estimated based on measurements from previous detector designs and smaller R&D devices.

Some full-sized SNOLAB detector prototypes have been tested at surface facilities, mostly at the K100 test facility at the University of Minnesota.



Detector design parameters

	Design Value		
Parameter	CDMS-HV iZIP		
Crystal Temperature	<30 mK		
TES Parameters			
Length	$200 \ \mu m$	$155 \ \mu m$	
Normal State Resistance	$150 \text{ m}\Omega$		
Operating Resistance	$50 \text{ m}\Omega$		
Loop Inductance	≪ 500 nH		
Shunt Resistance	$5 \text{ m}\Omega$		
Parasitic Resistance	$< 5 \text{ m}\Omega$		
$\alpha \left(\frac{R_0}{T_c} \frac{dR}{dT} \Big _{I_0} \right)$	~ 150		
$\left \beta\right \left(\frac{R_0}{T_0} \frac{dR}{dI} \right _{T_c} \right)$	< 0.3		
T_c	40-45 mK	40-60 mK	
Risetime (L/R)	$2-3 \ \mu s$	$2-4 \ \mu s$	
Falltime (τ_{TES})	$30-40 \ \mu s$	$10-40 \ \mu s$	
QET Parameters			
Geometry	"Stadium"	"Linear"	
Fin Length	$240 \ \mu m$	$80-110 \ \mu m$	
Trap Geometry	"Semicircle"	"Rectangle"	
Trap Length	$20 \ \mu m$	$5 \ \mu m$	
QET Number	~ 1800	~ 1400	
Energy Efficiency (ϵ_E)	15%	13%	
Aluminum Coverage	35%	4%	
Phonon Falltime (τ_{phonon}), Ge	$200 \ \mu s$	$1400 \ \mu s$	
Phonon Falltime (τ_{phonon}), Si	$40 \ \mu s$	$300 \ \mu s$	
Charge Input Capacitance	N/A	$\leq 300 \text{ pF}$	
Charge Channel		100-180 pF	
HEMT Input		100 pF	
Parasitic		20 pF	
Charge Collection Efficiency	N/A	95%	

